

June 2005 Revised August 2024

74LVT16373 • 74LVTH16373 Low Voltage 16-Bit Transparent Latch with 3-STATE Outputs

General Description

The LVT16373 and LVTH16373 contain sixteen non-inverting latches with 3-STATE outputs and is intended for bus oriented applications. The device is byte controlled. The flip-flops appear transparent to the data when the Latch Enable (LE) is HIGH. When LE is LOW, the data that meets the setup time is latched. Data appears on the bus when the Output Enable $(\overline{\text{OE}})$ is LOW. When $\overline{\text{OE}}$ is HIGH, the outputs are in a high impedance state.

The LVTH16373 data inputs include bushold, eliminating the need for external pull-up resistors to hold unused inputs.

These latches are designed for low-voltage (3.3V) V_{CC} applications, but with the capability to provide a TTL interface to a 5V environment. The LVT16373 and LVTH16373 are fabricated with an advanced BiCMOS technology to achieve high speed operation similar to 5V ABT which is maintaining a low power dissipation.

Features

- Input and output interface capability to systems at 5V V_{CC}
- Bushold data inputs eliminate the need for external pull-up resistors to hold unused ir (74LVTH16373), also available without bushold ture (1. 'VT16373)
- Live insertion/extraction r __mittec
- Power Up/Power Dow hint inpea se provides glitch-free bus load. 1
- Outputs sourc 'sink ? m, 34 m/\
- Functional col atibl with the 74 series 16373
- Latc _____ rmanue exceeds 500 mA
- L Dp forma...ce:

Hul n-L dy mcae! > 2000V

Machine model > 200V

Sharged-device model > 1000V

■ Also packaged in plastic Fine-Pitch Ball Grid Array (F3GA) (Freliminary)

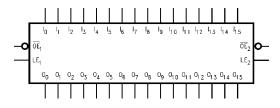
Ordering Code

Order Number	F 'umper	Package Description
74LVT16373CY (Note 1)	Preliminary)	54 Ball Fine-Pitch Bail Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide [TAPE and REEL]
74LVT165 RMEA (Note 2)	MS48A	48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
74LVT16373M (D (Note 2)	MTD48	48 Leao Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide
74LVTH16373GX (Note 1)	BGA54A (Preliminary)	54-Ball Fine-Pitch Ball Grid Array (FBGA), JEDEC MO-205, 5.5mm Wide [TAPE and REEL]
7/L/1H16373MEA (Note 2)	MS48A	48-Lead Small Shrink Outline Package (SSOP), JEDEC MO-118, 0.300" Wide
74LVTH16373MTD (Note 2)	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

Note 1: BGA package available in Tape and Reel only.

Note 2: Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Logic Symbol

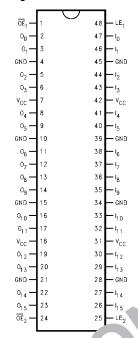


© 2005 Fairchild Semiconductor Corporation

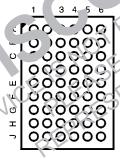
DS012021

Connection Diagrams

Pin Assignment for SSOP and TSSOP



Pin	Assign	fo	BGA



(Top Thru View)

Pin Descriptions

Pin Names	Description
OE _n	Output Enable Input (Active LOW)
LE _n	Latch Enable Input
I ₀ -I ₁₅	Inputs
O ₀ -O ₁₅	3-STATE Outputs
NC	No Connect

FBGA Pin Assignments

	1	2	3	4	5	6
Α	O ₀	NC	OE ₁	LE ₁	NC	I ₀
В	02	O ₁	NC	NC	I ₁	l ₂
С	O ₄	O ₃	7 -	, ;	l ₃	l ₄
D	O ₆	0	GNL	G D	15	l ₆
E	O ₈	_ (_	GND	GND	17	I ₈
F	710	O ₉ 7	.vD	GN:0	l ₉	I ₁₀
G	L C 2	1	Vcc	Vcc	I ₁₁	I ₁₂
	O ₁₄	ار 13	NC	NC	I ₁₃	I ₁₄
	15	NC	ŌE ₂	LE ₂	NC	I ₁₅

Tight Tables

SU.	Outputs		
LE ₁ O	QE,	I ₀ –I ₇	0 ₀ -0 ₇
X	H	Χ	Z
4/6/	L	L	L
Н	L	Н	н
L	L	X	O _o

	Outputs		
LE ₂	OE ₂	I ₈ -I ₁₅	O ₈ -O ₁₅
Х	Н	Х	Z
Н	L	L	L
Н	L	Н	Н
L	L	X	O _o

H = HIGH Voltage Level

- L = LOW Voltage Level
- X = Immaterial
- Z = HIGH Impedance

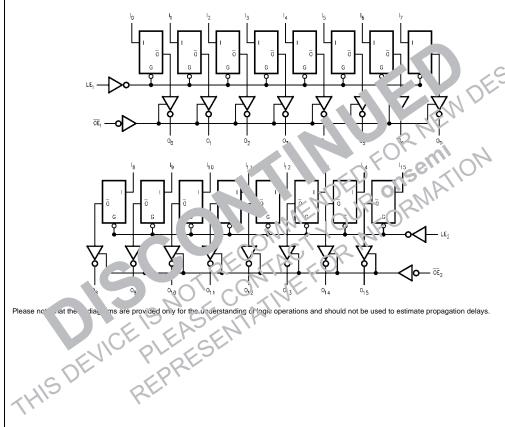
O_o = Previous output prior to HIGH-to-LOW transition of LE

Functional Description

The LVT16373 and LVTH16373 contain sixteen D-type latches with 3-STATE standard outputs. The device is byte controlled with each byte functioning identically, but independent of the other. Control pins can be shorted together to obtain full 16-bit operation. The following description applies to each byte. When the Latch Enable (LE_n) input is HIGH, data on the $\mathbf{D}_{\mathbf{n}}$ enters the latches. In this condition the latches are transparent, i.e, a latch output will change states each time its D input changes. When LE_n is LOW,

the latches store information that was present on the D inputs a setup time preceding the HIGH-to-LOW transition of LEn. The 3-STATE standard outputs are controlled by the Output Enable (\overline{OE}_n) input. When \overline{OE}_n is LOW, the standard outputs are in the 2-state mode. When $\overline{\text{OE}}_n$ is HIGH, the standard outputs are in the high impedance mode but this does not interfere with entering new data into the latches.

Logic Diagrams



 $\mathsf{T}_{\mathsf{STG}}$

Absolute Maximum Ratings(Note 3) Parameter Symbol Value Conditions Units -0.5 to +4.6 Supply Voltage ٧ V_{I} DC Input Voltage -0.5 to +7.0 Vo DC Output Voltage -0.5 to +7.0 Output in 3-STATE ٧ Output in HIGH or LOW State (Note 4) -0.5 to +7.0 DC Input Diode Current -50 $V_I < GND$ mΑ I_{IK} V_O < GND I_{OK} DC Output Diode Current -50 mΑ DC Output Current 64 $V_{O} > V_{CC}$ Output at HIGH State mΑ 128 Output at LOW State DC Supply Current per Supply Pin I_{CC} ±64 mΑ DC Ground Current per Ground Pin ±128 I_{GND}

Recommended Operating Conditions

Storage Temperature

Symbol	Parameter		in	Max	Units
V _{CC}	Supply Voltage	_	27	3.6	V
VI	Input Voltage	_/_	0	5.5	V
I _{ОН}	HIGH Level Output Current		2 12	-32	mA
l _{OL}	LOW Level Output Current			64	mA
T _A	Free-Air Operating Temperature	- 6	-40	85	°C
$\Delta t / \Delta V$	Input Edge Rate, V _{IN} = 0.8V–2.0V, V _{CC} = \ \V	\bigcirc	260	10	ns/V

-65 to +150

°C

Note 3: Absolute Maximum continuous ratings are those values. Fund a damage to the device may or at 2. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliations and open upon under absolute maximum rated conditions is not implied.

Note 4: I_O Absolute Maximum Rating must be observed.

DC Electrical Charac Pristics

Symbol	ramet		V _C (, T _A = 40°C to +85°C			Units	Conditions	
Cyllibol	Jamet	RV	(10)	Min	Max	Onits	Conditions	
V _{IK}	Inprit Ci Voltage	<u> </u>	2.7		-1.2	V	I _I = -18 mA	
V _{IH}	Inpu 'IGH Volta'		2.7-3.8	2.0		V	$V_O \le 0.1V$ or	
V _{IL}	i. It L V Voitage	CY	2.7-3.6		0.8	V	$V_O \ge V_{CC} - 0.1V$	
/он	Ou _st H.GH Voltage	12.00	2.7–3.6	V _{CC} - 0.2			$I_{OH} = -100 \mu A$	
			2.7	2.4		V	$I_{OH} = -8 \text{ mA}$	
		65	3.0	2.0			I _{OH} = -32 mA	
/ _{OL}	Cυάρυt LOW Voltage		2.7		0.2		I _{OL} = 100 μA	
G	281		2.7		0.5		I _{OL} = 24 mA	
7/2	QV.		3.0		0.4	V	I _{OL} = 16 mA	
			3.0		0.5		I _{OL} = 32 mA	
			3.0		0.55		I _{OL} = 64 mA	
I(HOLD)	Bushold Input Minimum Drive		3.0	75		μА	V _I = 0.8V	
Note 5)			3.0	-75		μΑ	V _I = 2.0V	
I(OD)	Bushold Input Over-Drive		3.0	500		μА	(Note 6)	
Note 5)	Current to Change State		3.0	-500		μΑ	(Note 7)	
I	Input Current		3.6		10		V _I = 5.5V	
		Control Pins	3.6		±1	μА	$V_I = 0V \text{ or } V_{CC}$	
		Data Pins	3.6		-5	μΑ	$V_I = 0V$	
		Data i ilis	3.0		1		$V_I = V_{CC}$	
OFF	Power Off Leakage Current		0		±100	μΑ	$0V \le V_I \text{ or } V_O \le 5.5V$	
PU/PD	Power Up/Down 3-STATE Output Current		0-1.5V		±100	μА	V _O = 0.5V to 3.0V	
			0-1.5		±100	μΑ	$V_I = GND \text{ or } V_{CC}$	
OZL	3-STATE Output Leakage Curre	ent	3.6		-5	μА	V _O = 0.5V	
OZH	3-STATE Output Leakage Curre	ent	3.6		5	μΑ	$V_0 = 3.0V$	
OZH ⁺	3-STATE Output Leakage Curre	ent	3.6		10	μΑ	$V_{CC} < V_O \le 5.5V$	

DC Electrical Characteristics (Continued)

Symbol	Parameter	V_{CC} $T_A = -40^{\circ}C \text{ to } +85^{\circ}C$		Units	Conditions	
- Cymbol	T didilicio	(V)	Min	Max	Omio	Conditions
I _{CCH}	Power Supply Current	3.6		0.19	mA	Outputs HIGH
I _{CCL}	Power Supply Current	3.6		5	mA	Outputs LOW
I _{CCZ}	Power Supply Current	3.6		0.19	mA	Outputs Disabled
I _{CCZ} +	Power Supply Current	3.6		0.19	mA	$V_{CC} \le V_O \le 5.5V$,
						Outputs Disabled
ΔI_{CC}	Increase in Power Supply Current	3.6		0.2	mA	One Input at V _{CC} – 0.6V
	(Note 8)					Other Inputs at V _{CC} or GND

Note 5: Applies to bushold versions only (74LVTH16373).

Note 6: An external driver must source at least the specified current to switch from LOW-to-HIGH.

Note 7: An external driver must sink at least the specified current to switch from HIGH-to-LOW.

Note 8: This is the increase in supply current for each input that is at the specified voltage level rather than V_{CC} or GND.

Dynamic Switching Characteristics (Note 9)

Symbol	Parameter	V _{CC}	T _A = 25°C			Conditions
Cymbol	i diametei	(V)	Min	Тур	Max	$C_L = 50 \text{ pF}, R_L = 500\Omega$
V _{OLP}	Quiet Output Maximum Dynamic V _{OL}	3.3		0.8		(Note 10)
V _{OLV}	Quiet Output Minimum Dynamic V _{OL}	3.3		-0.8		V (Note 10)

Note 9: Characterized in SSOP package. Guaranteed parameter, but not tested.

Note 10: Max number of outputs defined as (n). n-1 data inputs are driven 0V + V. C. out C. fer tescheld LOVV.

AC Electrical Characteristics

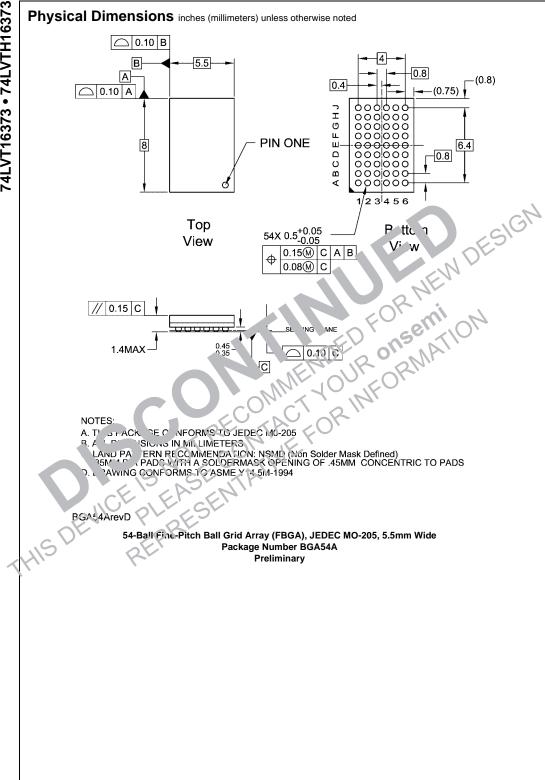
		TA	-40°C to +85°C,			
Symbol	Parameter	- cc = 3.3	3 V ± 0.3V	(V _C)	2.7V	Units
		Mir.	Mia:	N.(n	Max	
t _{PHL}	Propagation Delay	1.5	3.9	1.5	4.3	ns
t _{PLH}	D _n to O _n	1.5	3.8	1.5	4.2	ns
t _{PHL}	Propagati . Dulay	1.9	4.2	1.9	4.4	ns
t _{PLH}	LE + On	1.6	4.3	1.6	4.8	115
t _{PZL}	Outpu -nable Tim	1.3	4.3	1.3	4.9	ns
t _{PZH}	S CK	1.0	4.3	1.0	5.1	115
t _{PLZ}	Out Disable Time	1.5	4.7	1.5	4.8	ns
t _{PHZ}		2.0	5.0	2.0	5.4	115
t _S	Setup Time, Dn to LE	1.0		0.8		ns
t _H	Hc'u Time, D _n to LE	1.0		1.1		ns
t _W	LE Pulse Width	3.0		3.0		ns
toshl	Output to Output Skow (Note 11)		1.0		1.0	ns
toslh			1.0		1.0	115

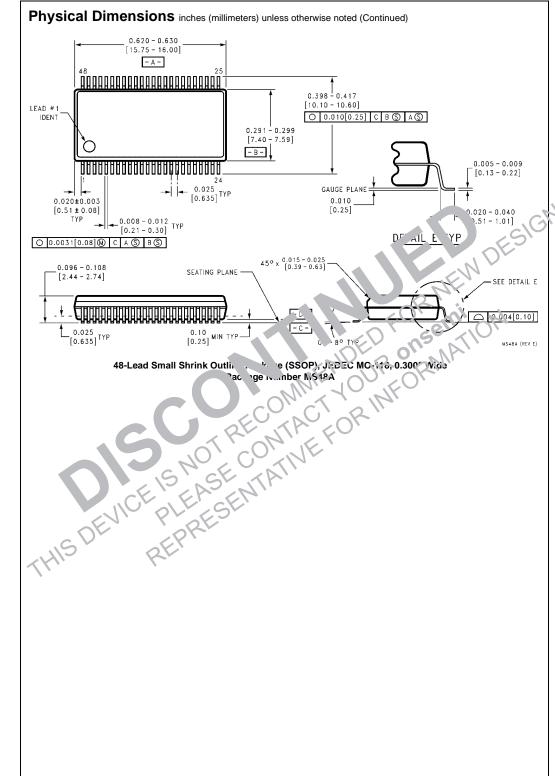
Note 11: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).

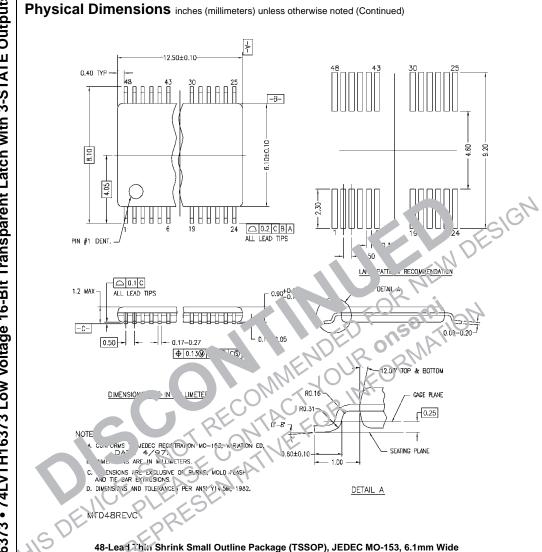
Capacitance (Note 12)

Symbol	Parameter	Conditions	Typical	Units
C _{IN}	Input Capacitance	$V_{CC} = Open, V_I = 0V \text{ or } V_{CC}$	4	pF
C _{OUT}	Output Capacitance	$V_{CC} = 3.0V$, $V_{O} = 0V$ or V_{CC}	8	pF

 $\textbf{Note 12:} \ \textbf{Capacitance is measured at frequency } \textbf{f} = \textbf{1 MHz, per MIL-STD-883, Method 3012.}$







Package Number MTD48

Fairchild does not assume any responsibility for use of any circuitry described, no circuit patent licenses are implied and Fairchild reserves the right at any time without notice to change said circuitry and specifications.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com



ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hol

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative